March 2006

FAIRCHILD SEMICONDUCTOR®

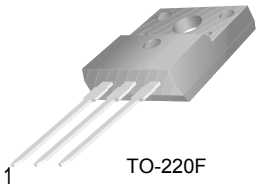
FFPF30UP20DP
Ultrafast Recovery Power Rectifier

Features

- Ultrafast with Soft Recovery : < 45ns (@I_F = 15A)
- High Reverse Voltage : V_{RRM} = 200V
- Avalanche Energy Rated
- Planar Construction

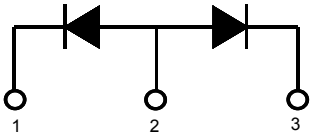
Applications

- Output Rectifiers
- Switching Mode Power Supply
- Free-wheeling diode for motor application
- Power switching circuits



TO-220F

1.Anode 2.Cathode 3.Anode



1. Cathode 2. Anode 3. Cathode

Absolute Maximum Ratings (per diode) T_C = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Peak Repetitive Reverse Voltage	200	V
V_{RWM}	Working Peak Reverse Voltage	200	V
V_R	DC Blocking Voltage	200	V
$I_{F(AV)}$	Average Rectified Forward Current @ T_C = 105°C	15	A
I_{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	150	A
T_J, T_{STG}	Operating Junction and Storage Temperature	- 65 to +150	°C

Thermal Characteristics

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.8	°C/W

Package Marking and Ordering Information

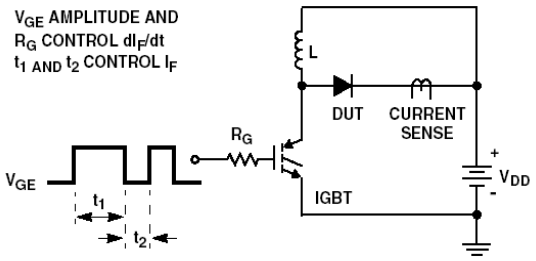
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F30UP20DP	FFPF30UP20DPTU	TO-220F	-	-	50

Electrical Characteristics (per diode) T_C = 25°C unless otherwise noted

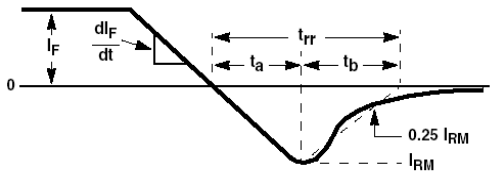
Symbol	Parameter		Min.	Typ.	Max.	Units
V_{FM} *	I_F = 15A I_F = 15A	T_C = 25 °C T_C = 100 °C	- -	- -	1.15 1.0	V V
I_{RM} *	V_R = 200V V_R = 200V	T_C = 25 °C T_C = 100 °C	- -	- -	100 500	μA μA
t_{rr}	I_F =1A, di/dt = 100A/μs, V_{CC} = 30V I_F =15A, di/dt = 200A/μs, V_{CC} = 130V	T_C = 25 °C T_C = 25 °C	- -	- -	35 45	ns ns
t_a t_b Q_{rr}	I_F =15A, di/dt = 200A/μs, V_{CC} = 130V	T_C = 25 °C T_C = 25 °C T_C = 25 °C	- - -	13 11 24	- - -	ns ns nC
W_{AVL}	Avalanche Energy (L = 40mH)		20	-	-	mJ

* Pulse Test: Pulse Width=300μs, Duty Cycle=2%

Test Circuit and Waveforms

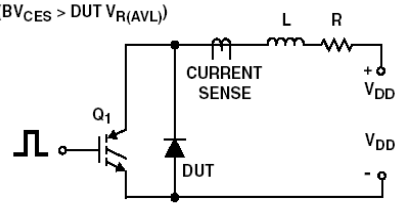


t_{rr} TEST CIRCUIT

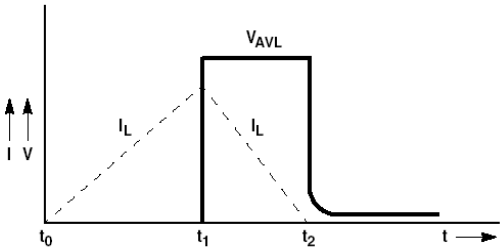


t_{rr} WAVEFORMS AND DEFINITIONS

I_{MAX} = 1A
L = 40mH
R < 0.1Ω
$E_{AVL} = 1/2LI^2 [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})]$
Q_1 = IGBT (BV_{CES} > DUT $V_{R(AVL)}$)



AVALANCHE ENERGY TEST CIRCUIT



AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Typical Performance Characteristics

Figure 1. Typical Forward Voltage Drop

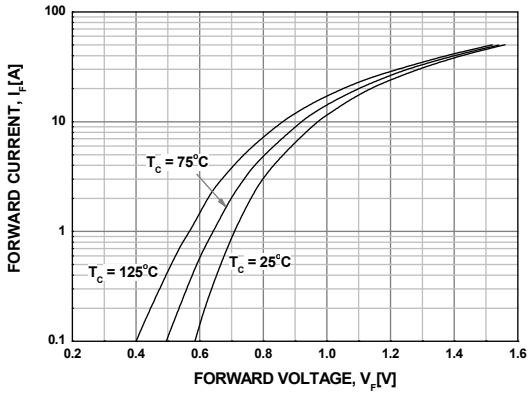


Figure 2. Typical Reverse Current

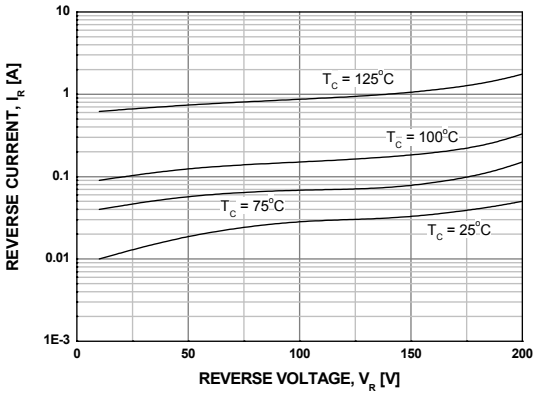


Figure 3. Typical Junction Capacitance

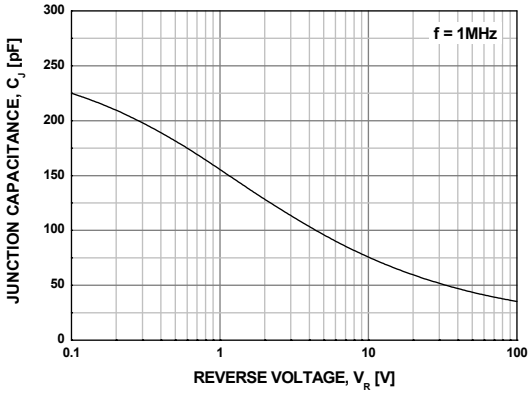


Figure 4. Typical Reverse Recovery Time

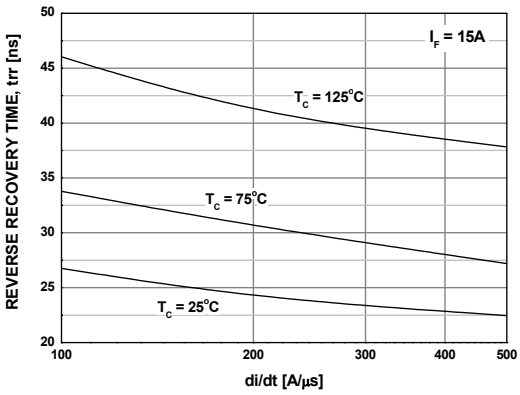


Figure 5. Typical Reverse Recovery Current

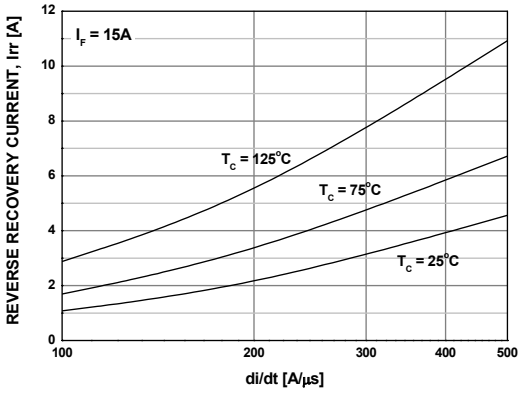
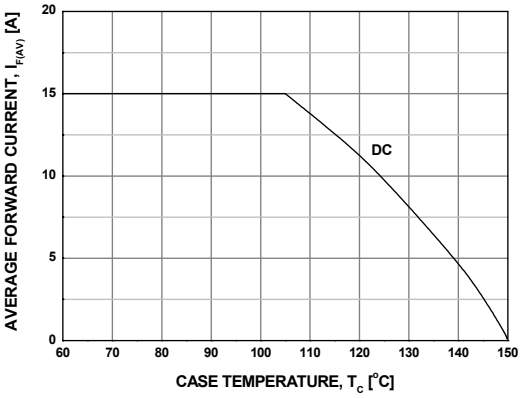
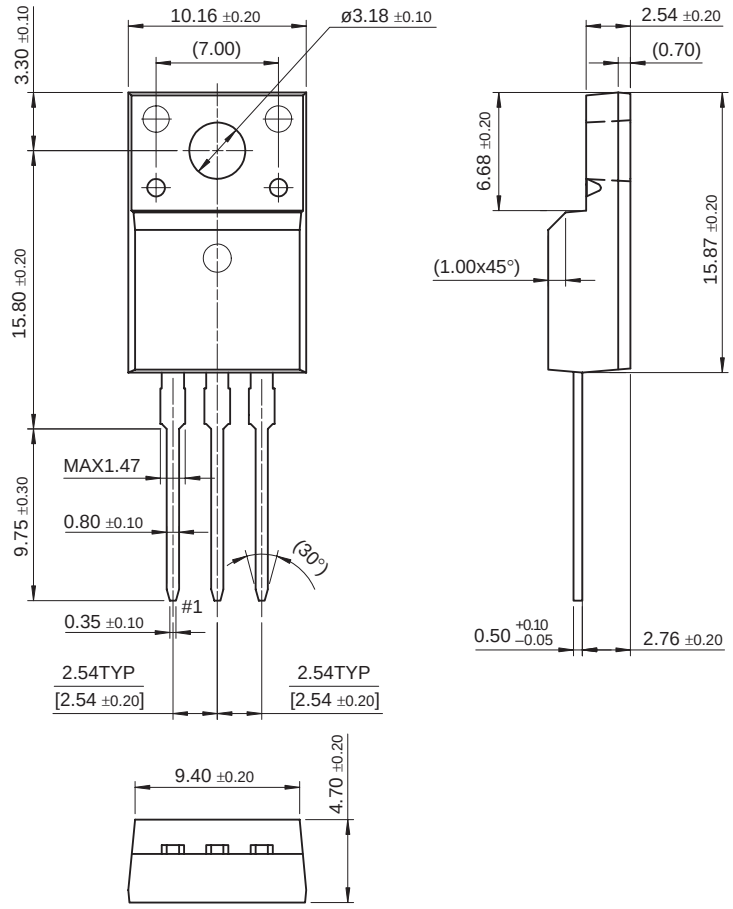


Figure 6. Forward Current Deration Curve



Package Demensions

TO-220F



Dimensions in Millimeters

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